

20 V, 6.2 A PNP low VCEsat transistor

9 January 2025

**Product data sheet** 

### 1. General description

PNP low  $V_{CEsat}$  transistor in a medium power and flat lead SOT89 (SC-62) Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS4021NX-Q

### 2. Features and benefits

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability  $I_C$  and  $I_{CM}$
- High collector current gain (h<sub>FE</sub>) at high I<sub>C</sub>
- High energy efficiency due to less heat generation
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

### 3. Applications

- Loadswitch
  - Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

### 4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-	-20	V
I <sub>C</sub>	collector current			-	-	-6.2	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-	-15	А
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_C$ = -4 A; $I_B$ = -400 mA; pulsed; $t_p \le$ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C		-	23	38	mΩ

### 5. Pinning information

### Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter		С
2	С	collector		в
3	В	base		5 hr E
			SOT89	006aaa231



# 6. Ordering information

Table 3. Ordering information					
Type number Package					
	Name	Description	Version		
PBSS4021PX-Q		plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	<u>SOT89</u>		

### 7. Marking

Table 4. Marking codes	
Type number	Marking code[1]
PBSS4021PX-Q	%6E

[1] % = placeholder for manufacturing site code

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

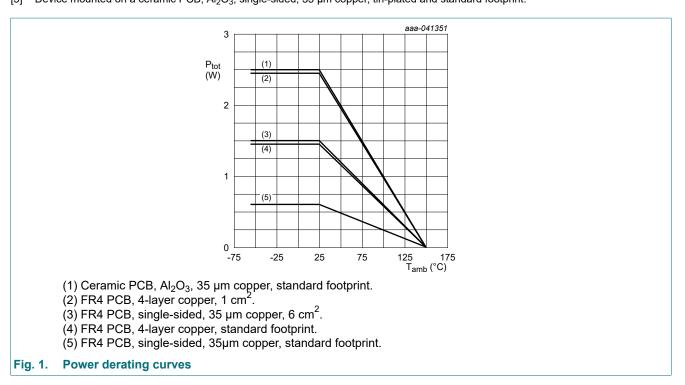
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	-20	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-20	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-5	V
l <sub>C</sub>	collector current			-	-6.2	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-15	А
I <sub>B</sub>	base current			-	-1	А
P <sub>tot</sub> total pow	total power dissipation	dissipation $T_{amb} \le 25 \degree C$	[1]	-	600	mW
			[2]	-	1.5	W
			[3]	-	1.45	W
			[4]	-	2.45	W
			[5]	-	2.5	W
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided, 35 µm copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
 [5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, single-sided, 35 µm copper, tin-plated and standard footprint.



### 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R <sub>th(j-a)</sub> thermal resistance fro junction to ambient		nction to ambient	[1]	-	-	208	K/W
	junction to ambient		[2]	-	-	83	K/W
			[3]	-	-	86	K/W
			[4]	-	-	51	K/W
			[5]	-	-	50	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	20	K/W

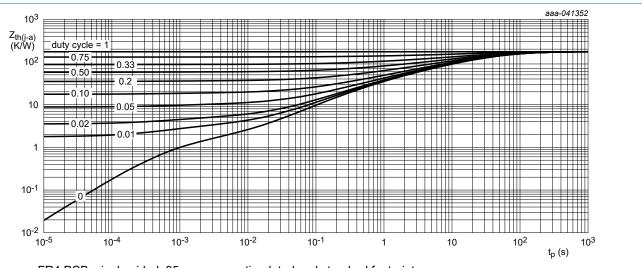
[1] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated and standard footprint.

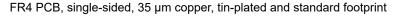
[2] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

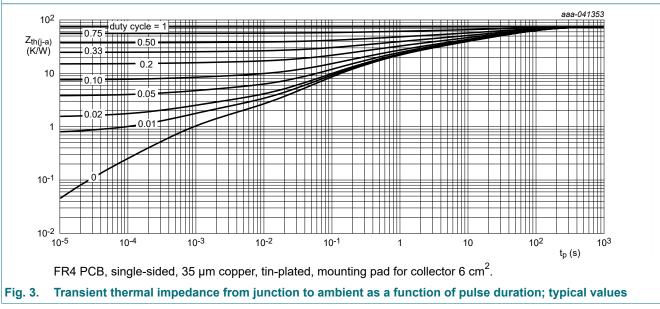
[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, single-sided, 35 µm copper, tin-plated and standard footprint.



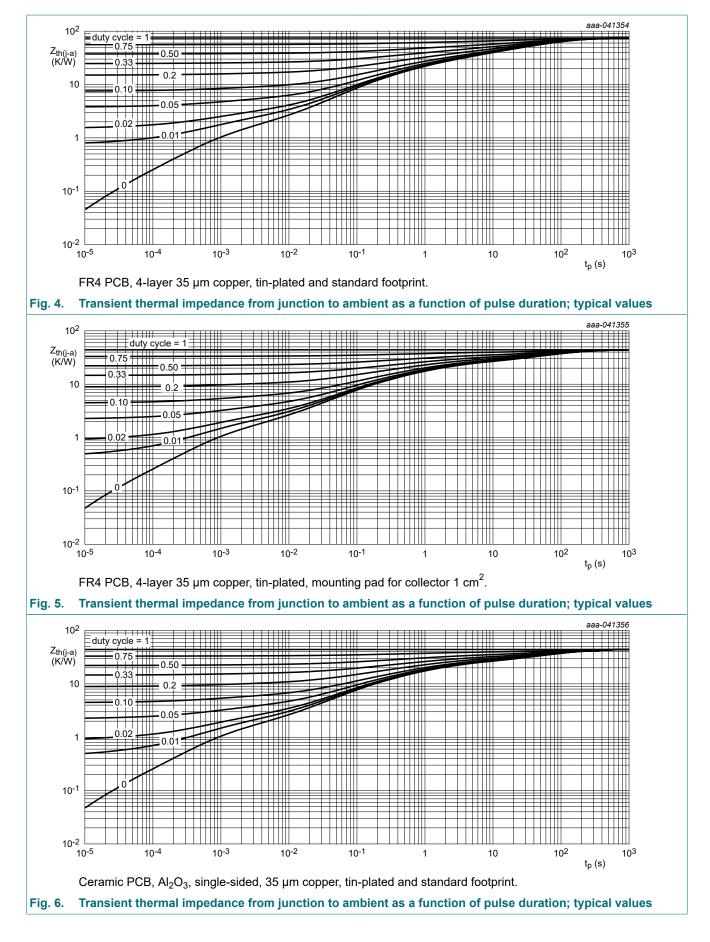








#### 20 V, 6.2 A PNP low VCEsat transistor

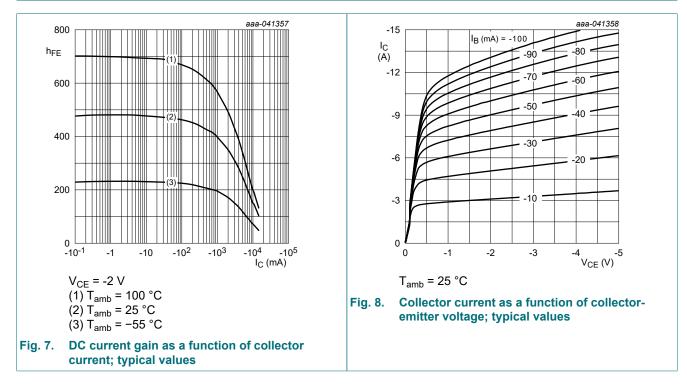


## **10. Characteristics**

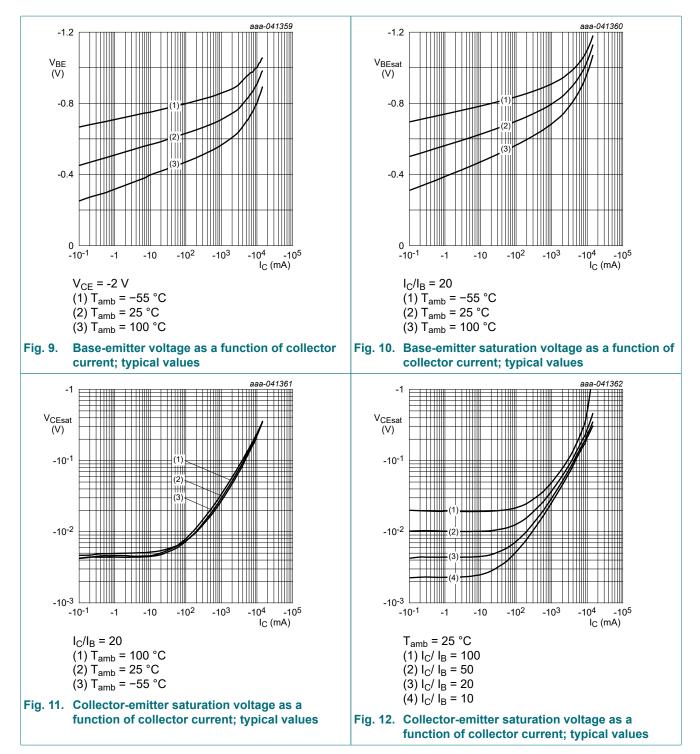
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)CBO</sub>	collector-base breakdown voltage	I <sub>C</sub> = -100 μA; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	-20	-	-	V
V <sub>(BR)CEO</sub>	collector-emitter breakdown voltage	I <sub>C</sub> = -10 mA; I <sub>B</sub> = 0 A; T <sub>amb</sub> = 25 °C	-20	-	-	V
V <sub>(BR)EBO</sub>	emitter-base breakdown voltage	I <sub>E</sub> = -100 μA; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	-5	-	-	V
I <sub>сво</sub>	collector-base cut-off	V <sub>CB</sub> = -20 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	-100	nA
	current	V <sub>CB</sub> = -20 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	-50	μA
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE}$ = -16 V; $V_{BE}$ = 0 V; $T_{amb}$ = 25 °C	-	-	-100	nA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = -2 V; I <sub>C</sub> = -0.5 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	250	425	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -1 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	250	405	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -2 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	200	355	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -4 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	150	290	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -7 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	80	210	-	
0204	collector-emitter saturation voltage	$I_C$ = -1 A; $I_B$ = -10 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-50	-90	mV
		I <sub>C</sub> = -1 A; I <sub>B</sub> = -50 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	-30	-50	mV
		$I_{C}$ = -2 A; $I_{B}$ = -40 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-60	-110	mV
		$I_{C}$ = -4 A; $I_{B}$ = -40 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-130	-270	mV
		$I_{C}$ = -4 A; $I_{B}$ = -200 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-90	-160	mV
		$I_{C}$ = -6.9 A; $I_{B}$ = -345 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-160	-265	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C}$ = -4 A; $I_{B}$ = -400 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	23	38	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_{C}$ = -1 A; $I_{B}$ = -100 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-0.82	-0.9	V
		$I_{C}$ = -4 A; $I_{B}$ = -400 mA; pulsed; $t_{p}$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	-0.93	-1.05	V
V <sub>BEon</sub>	base-emitter turn-on voltage	V <sub>CE</sub> = -2 V; I <sub>C</sub> = -2 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	-0.74	-0.85	V

### 20 V, 6.2 A PNP low VCEsat transistor

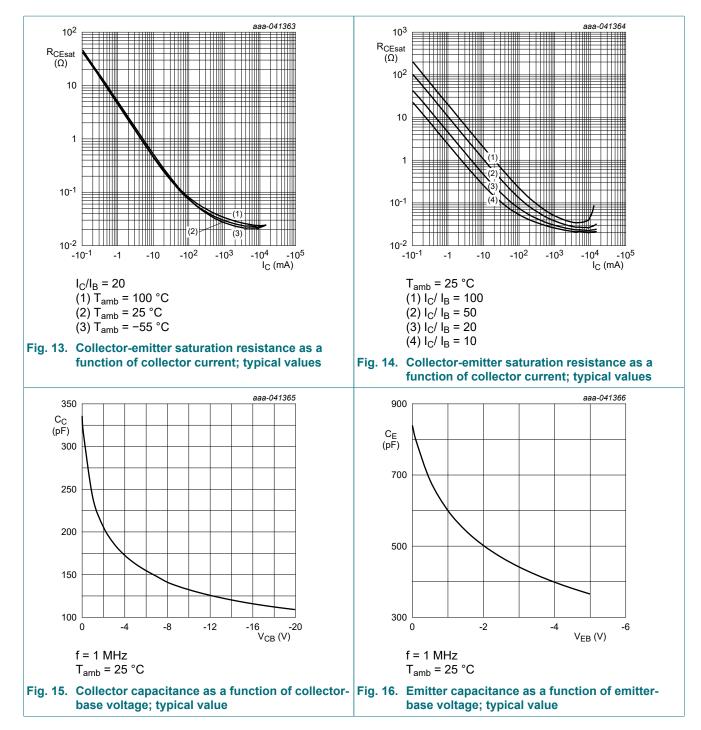
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>d</sub>	delay time	$V_{CC} = -12.5 \text{ V}; \text{ I}_{C} = -1 \text{ A}; \text{ I}_{Bon} = -50 \text{ mA};$ $\text{I}_{Boff} = 50 \text{ mA}; \text{ T}_{amb} = 25 \text{ °C}$	-	43	-	ns
t <sub>r</sub>	rise time		-	50	-	ns
t <sub>on</sub>	turn-on time		-	93	-	ns
t <sub>s</sub>	storage time		-	347	-	ns
t <sub>f</sub>	fall time		-	87	-	ns
t <sub>off</sub>	turn-off time		-	434	-	ns
f <sub>T</sub>	transition frequency	$V_{CE}$ = -10 V; I <sub>C</sub> = -100 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C	-	91	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = -10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	129	-	pF



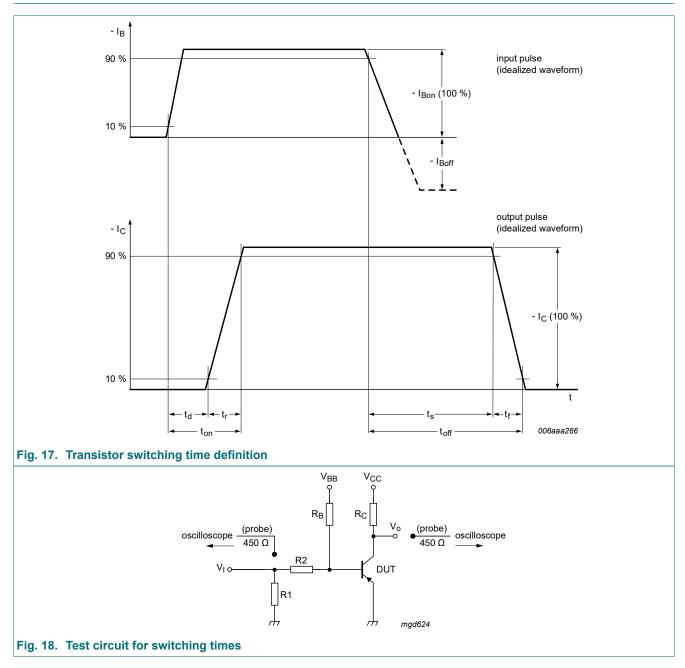
#### 20 V, 6.2 A PNP low VCEsat transistor



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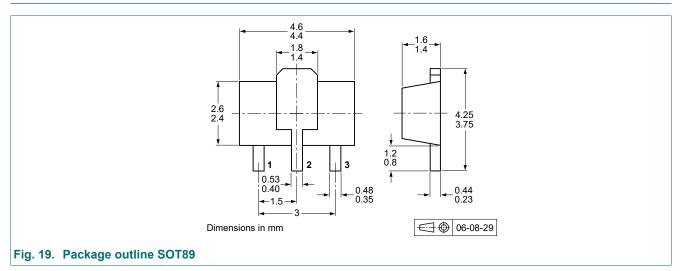
## **11. Test information**



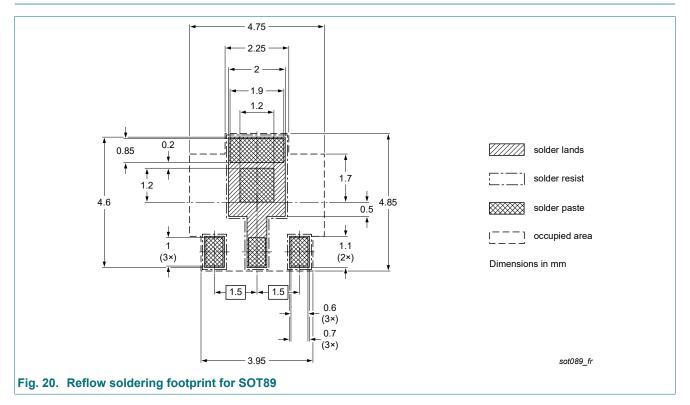
### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

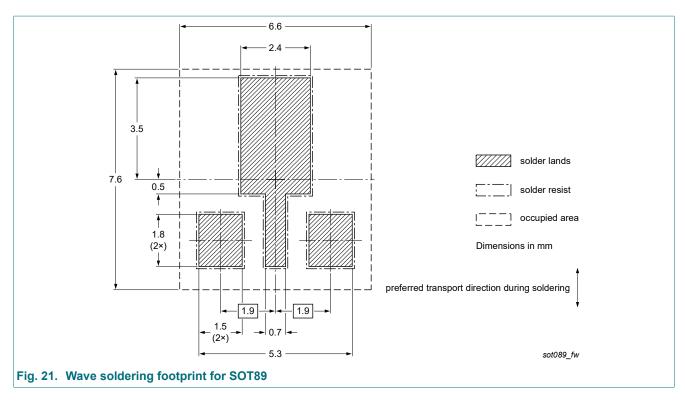
# 12. Package outline



### 13. Soldering



### 20 V, 6.2 A PNP low VCEsat transistor



# 14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PBSS4021PX-Q v.2	20250109	Product data sheet	-	PBSS4021PX-Q v.1			
Modifications:	New graphics and va	New graphics and values are added.					
PBSS4021PX-Q v.1	20240105	Product data sheet	-	-			

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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## Contents

1. Gene	eral description	1
2. Feat	ures and benefits	1
3. Appl	lications	1
4. Quic	k reference data	1
5. Pinn	ing information	1
6. Orde	ering information	2
7. Mark	king	2
8. Limi <sup>-</sup>	ting values	3
9. Ther	mal characteristics	4
10. Cha	aracteristics	6
11. Tes	t information	10
12. Pac	ckage outline	11
	dering	
14. Rev	vision history	13
15. Leg	gal information	14

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